SP1212 <u>12A Discr</u>ete Unidirectional TVS Diode

OBSOLETE DATE: 9/30/2021 PCN/ECN# ESU270-62 REPLACED BY: SP1250-01ETG





Additional Information





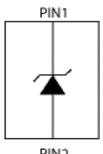


Samples

Resources

Accessories

Pinout and Functional Block Diagram



PIN2

Description

The SP1212 unidirectional TVS is fabricated in a proprietary silicon avalanche technology. These diodes provide a high ESD (electrostatic discharge) protection level for electronic equipment. The SP1212 TVS can safely absorb repetitive ESD strikes of ±30 kV (contact and air discharge as defined in IEC 61000-4-2) without any performance degradation. Additionally, each TVS can safely dissipate a 12A 8/20 surge event as defined in IEC 61000-4-5 2nd Edition.

Features & Benefits

- ESD, IEC 61000-4-2, ±30kV contact, ±30kV air
- EFT, IEC 61000-4-4, 40A (5/50ns)
- Lightning, 12A (8/20µs as defined in IEC 61000-4-5 2nd edition)

Applications

- Switches / Buttons
- Test Equipment / Instrumentation
- Point-of-Sale Terminals
- Medical Equipment

- AEC-Q101 qualified
- Lead free and RoHS compliant
- Moisture Sensitivity Level(MSL -1)
- Notebooks / Desktops / Servers
- Computer Peripherals
- Battery

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.





Absolute Maximum Ratings

Symbol	Parameter	Value	Units
P _{pk}	Peak Pulse Power (t _p =8/20µs)	250	W
Τ _{ορ}	Operating Temperature	-40 to 125	°C
T _{stor}	Storage Temperature	-55 to 150	°C

Caution: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Electrical Characteristics (T_{op}=25°C)

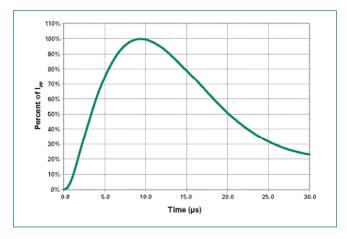
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Reverse Standoff Voltage	V _{RWM}	I _R =1µA			5.0	V
Breakdown Voltage	V _{BR}	I _R =1mA		7.0		V
Reverse Leakage Current	I _{LEAK}	V _R =5V		0.1	0.5	μΑ
Clamp Voltage ¹	V _c	I _{PP} =1Α, t _p =8/20μs		7.5		V
		I _{PP} =12A, t _P =8/20μs		9.7		V
Dynamic Resistance ²	R _{DYN}	TLP, t_p =100ns, I/O to GND		0.33		Ω
Peak Pulse Current	l _{pp}	t _p =8/20µs		12		А
ESD Withstand Voltage ¹	V_{ESD}	IEC 61000-4-2 (Contact Discharge)	±30			kV
		IEC 61000-4-2 (Air Discharge)	±30			kV
Diode Capacitance ¹	C _{I/O-GND}	Reverse Bias=0V, f=1MHz		290		pF

Note:

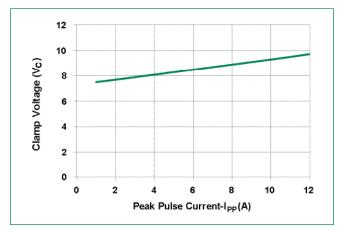
1. Parameter is guaranteed by design and/or component characterization.

2. Transmission Line Pulse (TLP) with 100ns width, 2ns rise time, and average window t1=70ns to t2= 90ns

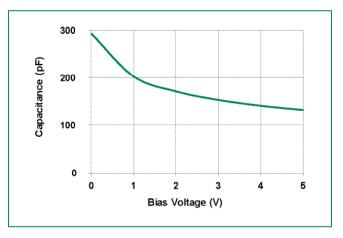
8/20µs Pulse Waveform



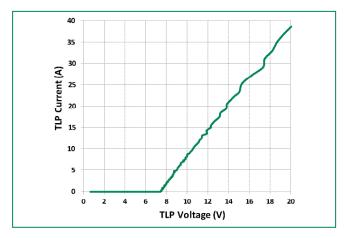
Clamping Voltage vs IPP for 8/20µs waveshape



Capacitance vs. Bias



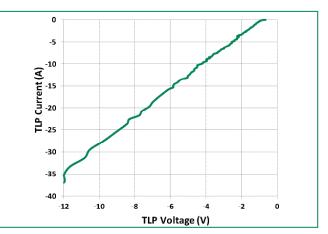
Positive Transmission Line Pulsing (TLP) Plot



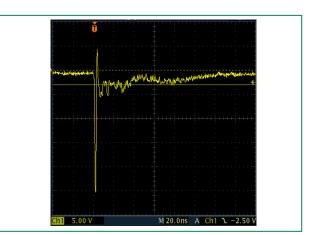
IEC 61000-4-2 +8 kV Contact ESD Clamping Voltage



Negative Transmission Line Pulsing (TLP) Plot



IEC 61000-4-2 -8 kV Contact ESD Clamping Voltage





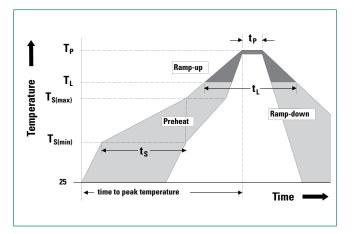
TVS Diode Arrays Datasheet

Soldering Parameters

Part Number

SP1212-01ETG

Reflow Condition		Pb – Free assembly		
Pre Heat	- Temperature Min (T _{s(min)})	150°C		
	- Temperature Max (T _{s(max)})	200°C		
	- Time (min to max) (t _s)	60 – 180 secs		
Average rar to peak	np up rate (Liquidus) Temp (T _L)	3°C/second max		
$T_{S(max)}$ to T_L - Ramp-up Rate		3°C/second max		
Reflow	- Temperature (T _L) (Liquidus)	217°C		
	- Temperature (t _L)	60 – 150 seconds		
Peak Tempe	rature (T _P)	260 ^{+0/-5} °C		
Time within 5°C of actual peak Temperature $(t_{\mbox{\tiny p}})$		20 – 40 seconds		
Ramp-down Rate		6°C/second max		
Time 25°C to peak Temperature (T _P)		8 minutes Max.		
Do not exce	ed	260°C		



Product Characteristics

Lead Plating	Matte Tin
Lead Material	Copper Alloy
Substrate Material	Silicon
Body Material	Molded Compound
Flammability	UL Recognized compound meeting flammability rating V-0

Ordering Information

Package

SOD882

Min. Order Qty.

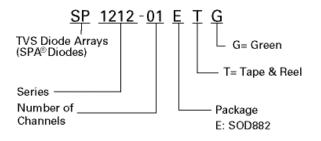
10000

Part Marking System

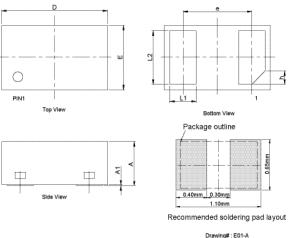


F = Part Code * = Date Code

Part Numbering System



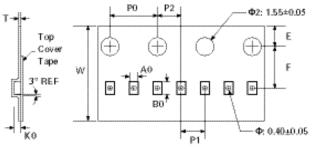
Package Dimensions – SOD882

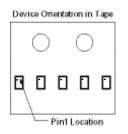


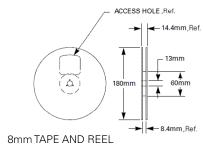
	Package			SOD882			
Symbol	JEDEC			MO-236			
Gymbol		Millimeters	;	Inches			
	Min	Тур	Max	Min	Тур	Мах	
Α	0.50	0.55	0.60	0.020	0.022	0.024	
A1	0.00	0.02	0.05	0.000	0.001	0.002	
L1	0.20	0.25	0.30	0.008	0.010	0.012	
L2	0.45	0.50	0.55	0.018	0.020	0.022	
D	0.90	1.00	1.10	0.035	0.039	0.043	
Е	0.50	0.60	0.70	0.020	0.024	0.028	
е		0.65 BSC			0.026 BSC		
h	0.	.125 (x 45°)		0.005 (x 45°)			

Drawing# . E0 PA

Embossed Carrier Tape & Reel Specification - SOD882







Tape Dimensions				
Symbol	Millimeters			
Symbol	Min	Max		
A0	0.65	0.75		
B0	1.10	1.20		
К0	0.50	0.60		
Е	1.65	1.85		
F	3.45	3.55		
P0	3.90	4.10		
P1	1.90	2.10		
P2	1.95	2.05		
т	1.95	2.05		
W	7.90	8.10		

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